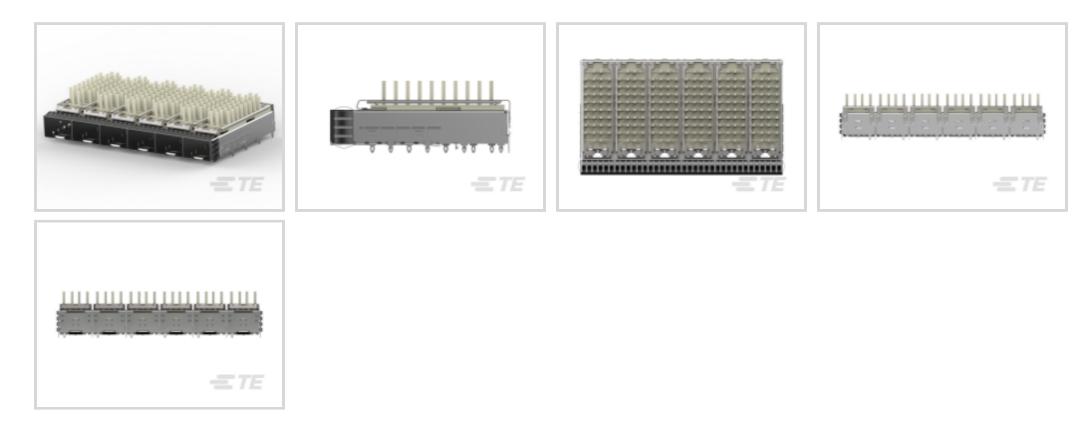
# 2198235-3 - ACTIVE

TE Internal #: 2198235-3 SFP, SFP+ & zSFP+, Cage Assembly, Data Rate (Max) 16 Gb/s, External Springs, SFP+ Enhanced, 1 x 6, Pin, Heat Sink Height 9.1 mm [.358 in]

View on TE.com >

Connectors > Pluggable IO Connectors & Cages > SFP, SFP+ & zSFP+



Pluggable I/O Product Type: Cage Assembly

Data Rate (Max): 16 Gb/s

EMI Containment Feature Type: External Springs

Pluggable I/O Applications: SFP+ Enhanced

Thermal Accessory Type Included: Heat Sink

## Features

#### Product Type Features



Form Factor	SFP+
Cage Туре	Ganged
Pluggable I/O Product Type	Cage Assembly
Thermal Accessory Type Included	Heat Sink
Connector System	Cable-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Port Matrix Configuration	1 x 6
Number of Ports	6
Electrical Characteristics	
Data Rate (Max)	16 Gb/s
Body Features	
Heat Sink Style	Pin

SFP, SFP+ & zSFP+, Cage Assembly, Data Rate (Max) 16 Gb/s, External Springs, SFP+ Enhanced, 1 x 6, Pin, Heat Sink Height 9.1 mm [.358 in]



Heat Sink Height Class	Short
Heat Sink Height	9.1 mm[.358 in]
Termination Features	
Termination Method to Printed Circuit Board	Through Hole - Press-Fit
Mechanical Attachment	
PCB Mounting Style	Through Hole - Press-Fit
Connector Mounting Type	Board Mount
Housing Features	
Cage Material	Nickel Silver
Dimensions	
Tail Length	2.05 mm[.081 in]
PCB Thickness (Recommended)	2.25 mm[.089 in]
Usage Conditions	
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
Operation/Application	
Heat Sink Compatible	Yes
For Use With Pluggable I/O Products	SFP+ SMT Connector
Pluggable I/O Applications	SFP+ Enhanced
Circuit Application	Signal
Packaging Features	
Packaging Method	Box & Tray, Package
Other	
EMI Containment Feature Type	External Springs
Included Lightpipe	No
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224)

SFP, SFP+ & zSFP+, Cage Assembly, Data Rate (Max) 16 Gb/s, External Springs, SFP+ Enhanced, 1 x 6, Pin, Heat Sink Height 9.1 mm [.358 in]



Candidate List Declared Against: JAN 2022 (223) SVHC > Threshold: Not Yet Reviewed

Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Halogen Content

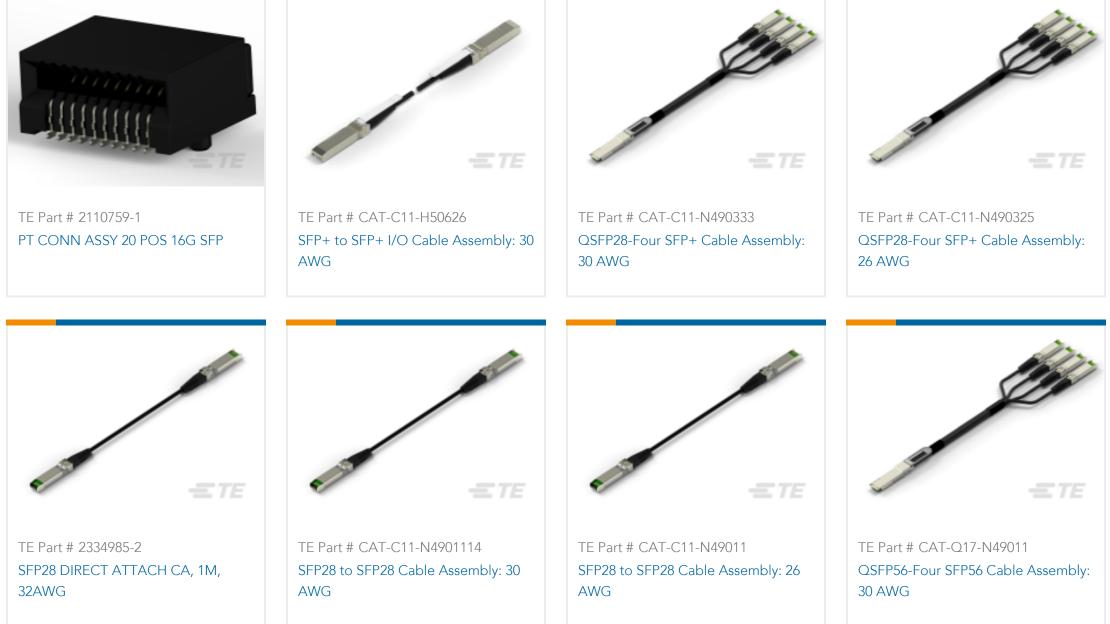
#### Solder Process Capability

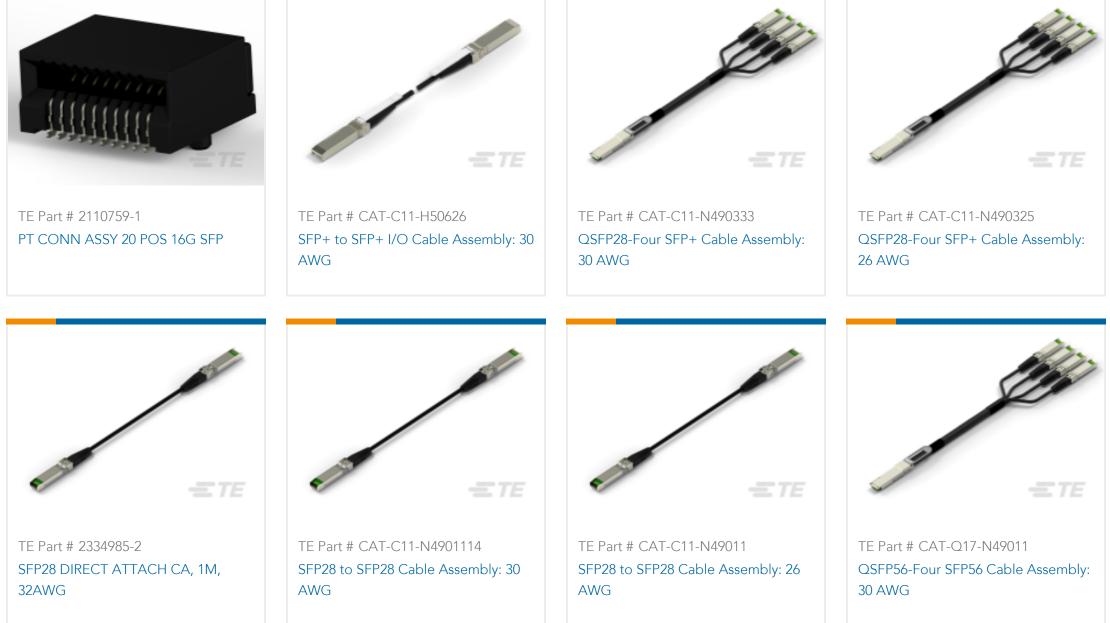
Not applicable for solder process capability

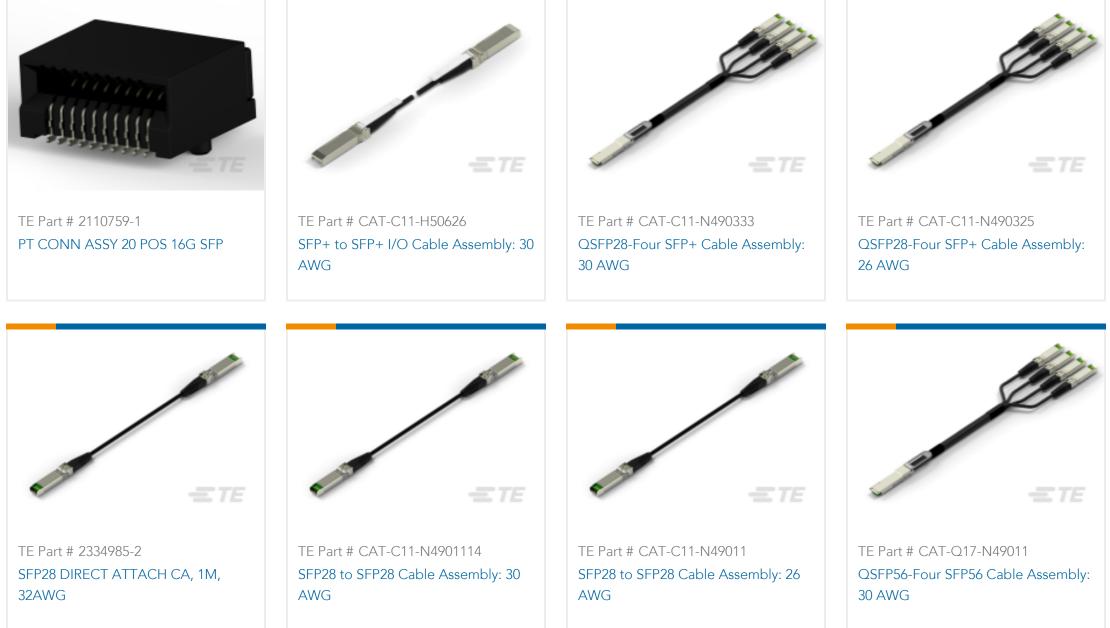
#### Product Compliance Disclaimer

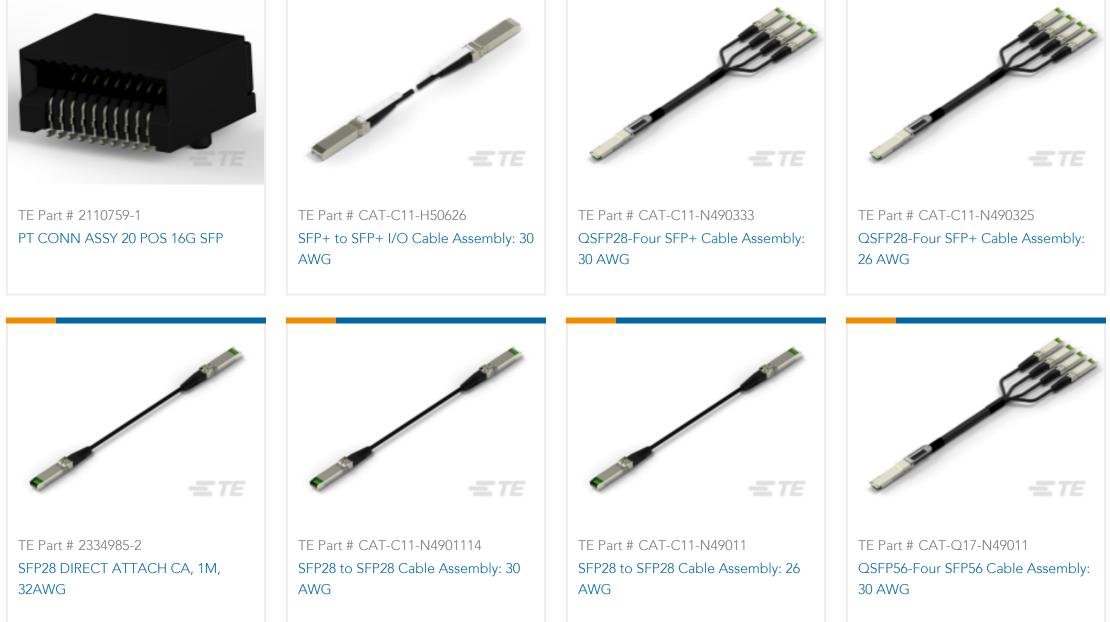
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

# **Compatible Parts**



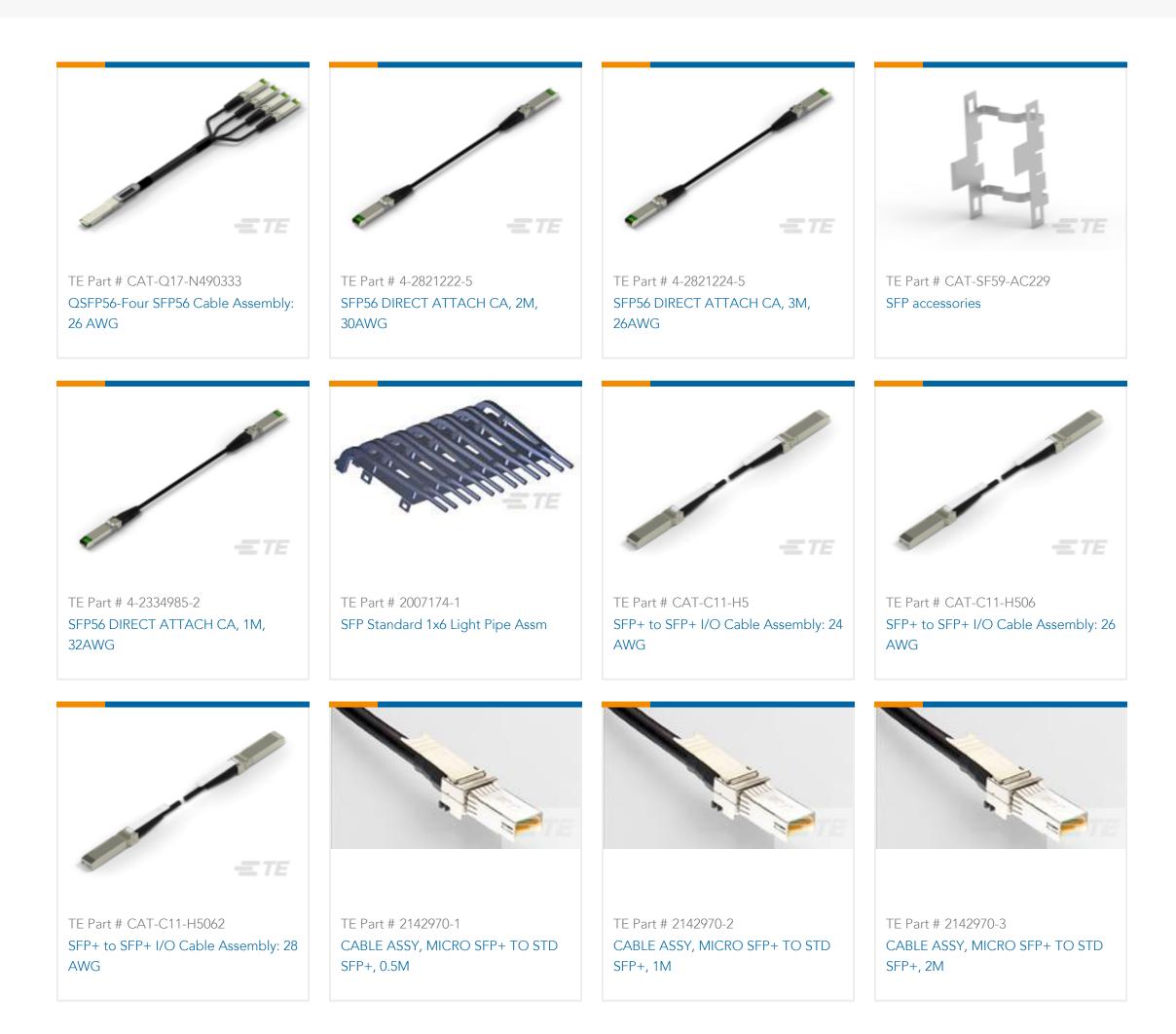






SFP, SFP+ & zSFP+, Cage Assembly, Data Rate (Max) 16 Gb/s, External Springs, SFP+ Enhanced, 1 x 6, Pin, Heat Sink Height 9.1 mm [.358 in]





# **Customers Also Bought**



SFP, SFP+ & zSFP+, Cage Assembly, Data Rate (Max) 16 Gb/s, External Springs, SFP+ Enhanced, 1 x 6, Pin, Heat Sink Height 9.1 mm [.358 in]



 TE Part #1645681-1
 TE Part #6-2170705-3

 ZP HS3 DB 06R REC 030P LE PD
 CAGE ASSY, QSFP28 1X1, SPRING, HS, LP

# Documents

# Product Drawings

## SFP+ Enhanced 1x6, Networking Heatsink

English

### **CAD** Files

Customer View Model ENG\_CVM\_CVM\_2198235-3\_A.2d\_dxf.zip

English

#### 3D PDF

3D

Customer View Model

ENG\_CVM\_CVM\_2198235-3\_A.3d\_igs.zip

English

Customer View Model

#### ENG\_CVM\_CVM\_2198235-3\_A.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications Application Specification

English

Product Environmental Compliance

**TE Material Declaration** 

English